

ACPL-224 / ACPL-244

AC Input Multi-Channel Half-Pitch Phototransistor Optocoupler

AVAGO
TECHNOLOGIES

Data Sheet



Lead (Pb) Free
RoHS 6 fully
compliant

RoHS 6 fully compliant options available;
-xxxE denotes a lead-free product

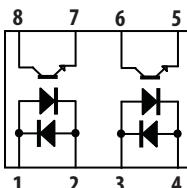
Description

The ACPL-224 is an AC-input dual channel half-pitch phototransistor optocoupler each of which contains 2 light emitting diodes connected inversely parallel & optically coupled to 2 separate phototransistors. It is packaged in an 8-pin SO package.

Likewise, the ACPL-244 is an AC-input quad channel half-pitch phototransistor optocoupler each of which contains 2 light emitting diodes connected inversely parallel & optically coupled to 4 separate phototransistors. It is packaged in a 16-pin SO package.

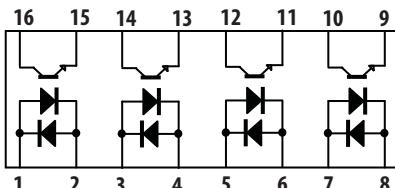
For both devices, the input-output isolation voltage is rated at 3,000 Vrms. Response time, tr, is 2 μ s typically, while minimum CTR is 20% at input current of ± 1 mA.

ACPL-224 pin



| | |
|----------|-------------------|
| Pin 1, 3 | Anode/ Cathode |
| Pin 2, 4 | Cathode/ Anode |
| Pin 5, 7 | Emitter |
| Pin 6, 8 | Collector |

ACPL-244 pin



| | |
|-----------------|---------------|
| Pin 1, 3, 5, 7 | Anode/Cathode |
| Pin 2, 4, 6, 8 | Cathode/Anode |
| Pin 9,11,13,15 | Emitter |
| Pin 10,12,14,16 | Collector |

Features

- Current transfer ratio (CTR: 20% (min) at $I_F = \pm 1$ mA, $V_{CE} = 5$ V)
- High input-output isolation voltage ($V_{ISO} = 3,000$ V_{RMS})
- Non-saturated Response time (t_r : 2 μ s (typ) at $V_{CC} = 10$ V, $I_C = 2$ mA, $R_L = 100\Omega$)
- SO package
- CMR 10kV/ μ s (typical)
- Safety and regulatory approvals
 - cUL
 - IEC/EN/DIN EN 60747-5-2
- Options available:
 - CTR Rank '0' only

Applications

- I/O Interface for Programmable controllers, computers.
- Sequence controllers
- System appliances, measuring instruments
- Signal transmission between circuits of different potentials and impedances.

Ordering Information

ACPL-2x4-xxxx is UL Recognized at 3,000 Vrms for 1 minute per UL1577 and Canadian Component Acceptance Notice #5.

| Part number | RoHS Compliant Option | | | | | | | Quantity |
|-------------|--|---------|--------------------|------------------|----------------|--------------------------------|-------------------|----------|
| | Rank '0', 20%<CTR<400%, $I_F = \pm 1\text{mA}$, $V_{CE} = 5V$ | Package | No. Of Channels | Surface Mount | Tape & Reel | IEC / EN / DIN EN 60747-5-2 | | |
| ACPL-224 | -500E | SO-8 | Dual | X | X | | 2000 pcs per reel | |
| | -560E | SO-8 | Dual | X | X | X | 2000 pcs per reel | |
| ACPL-244 | -500E | SO-16 | Quad | X | X | | 2000 pcs per reel | |
| | -560E | SO-16 | Quad | X | X | X | 2000 pcs per reel | |

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

ACPL-224-560E to order product of Dual Channel SO-8 Surface Mount package in Tape & Reel with IEC/EN/DIN EN 60747-5-2 Safety Approval, 20%<CTR<400% and RoHS compliant.

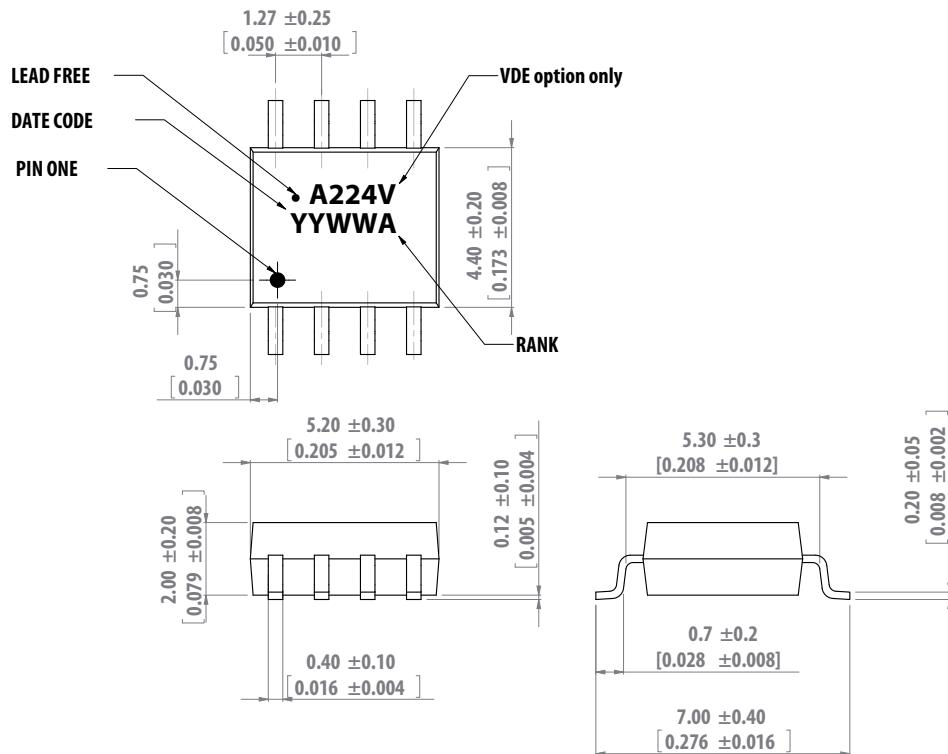
Example 2:

ACPL-244-500E to order product of Quad Channel SO-16 Surface Mount package in Tape and Reel packaging with 20%<CTR<400% and RoHS compliant.

Option datasheets are available. Contact your Avago sales representative or authorized distributor for information.

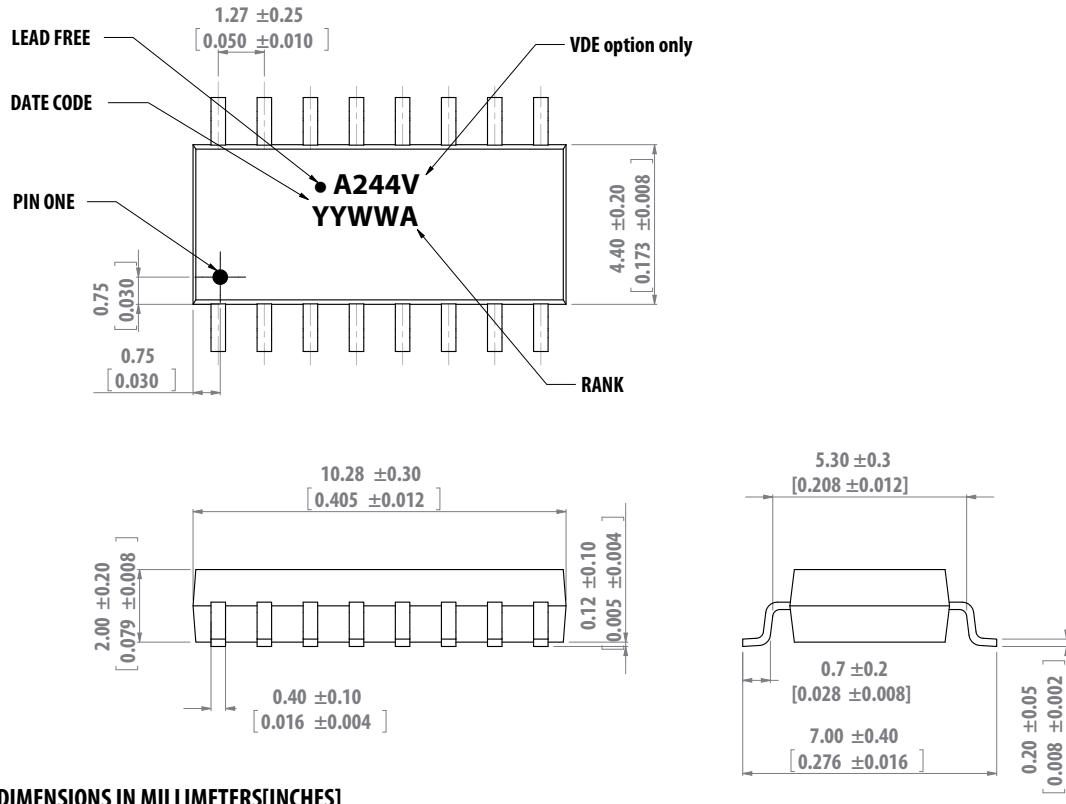
Package Outline Drawings

ACPL-224 Package Outline



DIMENSIONS IN MILLIMETERS [INCHES]

ACPL-244 Package Outline



DIMENSIONS IN MILLIMETERS [INCHES]

Solder Reflow Temperature Profile

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision). Non-Halide Flux should be used.

Absolute Maximum Ratings

| Parameter | Symbol | ACPL-224 | ACPL-244 | Units | Note |
|--|---------------------|----------------------|----------|------------------|------|
| Storage Temperature | T _S | -55~125 | | °C | |
| Operating Temperature | T _A | -55~110 | | °C | |
| Average Forward Current | I _{F(AVG)} | ±50 | | mA | |
| Pulse Forward Current | I _{FSM} | ±1 | | A | |
| Reverse Voltage | V _R | 6 | | V | |
| LED Power Dissipation (1 channel) | P _I | 65 | | mW | |
| Collector Current | I _C | 50 | | mA | |
| Collector-Emitter Voltage | V _{CEO} | 80 | | V | |
| Emitter-Collector Voltage | V _{ECO} | 7 | | V | |
| Isolation Voltage (AC for 1min, R.H. 40~60%) | V _{ISO} | 3,000 | | V _{RMS} | 1min |
| Collector Power Dissipation (1 channel) | P _C | 150 | 100 | mW | |
| Total Power Dissipation | P _{TOT} | 200 | 170 | mW | |
| Lead Solder Temperature | | 260°C for 10 seconds | | | |

Electrical Specifications (DC)

Over recommended ambient temperature at 25°C unless otherwise specified.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Test Conditions | Note |
|--------------------------------------|----------------------|--------------------|--------------------|------|-------------------|---|---------------------------|
| Forward Voltage | V_F | - | 1.2 | 1.4 | V | $I_F = \pm 20\text{mA}$ | Fig.6 |
| Reverse Current | I_R | - | - | 10 | μA | $V_R = 5\text{V}$ | |
| Terminal Capacitance | C_t | - | 30 | - | pF | $V = 0, f = 1\text{MHz}$ | |
| Collector Dark Current | I_{CEO} | - | - | 100 | nA | $V_{CE} = 48\text{V}, I_F = 0\text{mA}$ | Fig.12 |
| Collector-Emitter Breakdown Voltage | BV_{CEO} | 80 | - | - | V | $I_C = 0.5\text{mA}, I_F = 0\text{mA}$ | |
| Emitter-Collector Breakdown Voltage | BV_{ECO} | 7 | - | - | V | $I_E = 100\text{\mu A}, I_F = 0\text{mA}$ | |
| Current Transfer Ratio | CTR | 20 | - | 400 | % | $I_F = \pm 1\text{mA}, V_{CE} = 5\text{V}$ | $CTR = (I_C/I_F) * 100\%$ |
| Saturated CTR | CTR(sat) | - | 60 | - | % | $I_F = \pm 1\text{mA}, V_{CE} = 0.4\text{V}$ | |
| Collector-Emitter Saturation Voltage | $V_{CE}(\text{sat})$ | - | - | 0.4 | V | $I_F = \pm 8\text{mA}, I_C = 2.4\text{mA}$ | Fig.14 |
| Isolation Resistance | R_{iso} | 5×10^{10} | 1×10^{11} | - | Ω | DC500V, R.H. 40~60% | |
| Floating Capacitance | C_F | - | 0.6 | 1 | pF | $V = 0, f = 1\text{MHz}$ | |
| Cut-off Frequency (-3dB) | F_C | - | 80 | - | kHz | $V_{CC} = 5\text{V}, I_C = 2\text{mA}, R_L = 100\Omega$ | Fig. 2,19 |
| Response Time (Rise) | t_r | - | 2 | - | μs | $V_{CC} = 10\text{V}, I_C = 2\text{mA}, R_L = 100\Omega$ | Fig. 1 |
| Response Time (Fall) | t_f | - | 3 | - | μs | | |
| Turn-on Time | t_{on} | - | 3 | - | μs | | |
| Turn-off Time | t_{off} | - | 3 | - | μs | | |
| Turn-ON Time | t_{ON} | - | 2 | - | μs | $V_{CC} = 5\text{V}, I_F = \pm 16\text{mA}, R_L = 1.9\text{k}\Omega$ | Fig. 1, 17 |
| Storage Time | T_S | - | 25 | - | μs | | |
| Turn-OFF Time | t_{OFF} | - | 40 | - | μs | | |
| Common Mode Rejection Voltage | CMR | - | 10 | - | kV/ μs | $T_a=25^\circ\text{C}, R_L=470\Omega, V_{CM}=1.5\text{kV(peak)}, I_F=0\text{mA}, V_{CC}=9\text{V}, V_{hp}=100\text{mV}$ | Fig.20 |

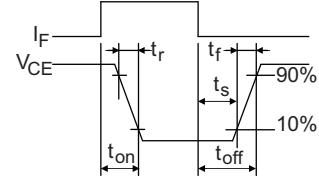
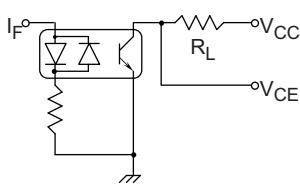


Figure 1. Switching Time Test Circuit

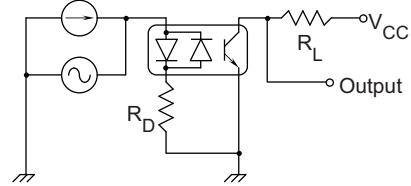


Figure 2. Frequency Response Test Circuit

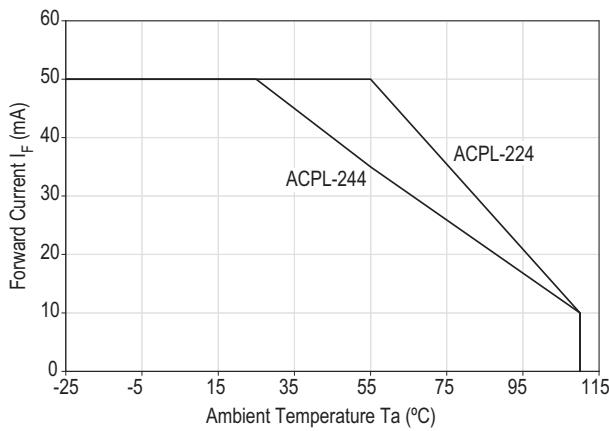


Figure 3. Forward Current vs. Ambient Temperature

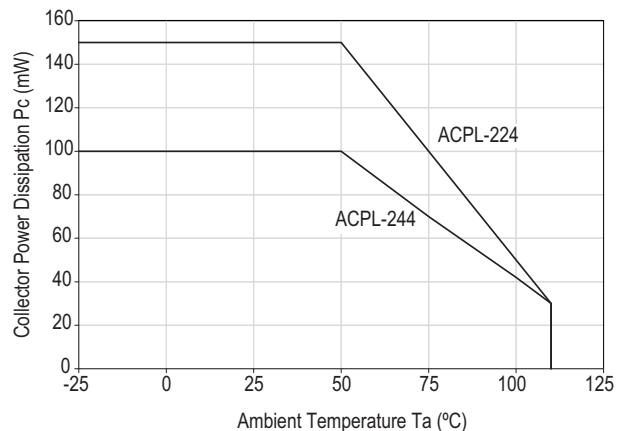


Figure 4. Collector Power Dissipation vs. Ambient Temperature

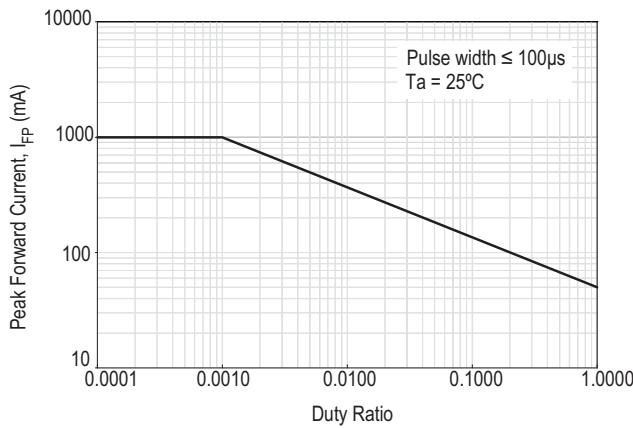


Figure 5. Pulse Forward Current vs. Duty Cycle Ratio

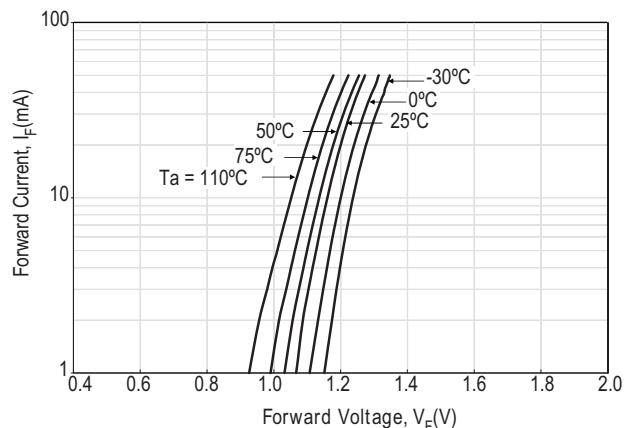


Figure 6. Forward Current vs. Forward Voltage

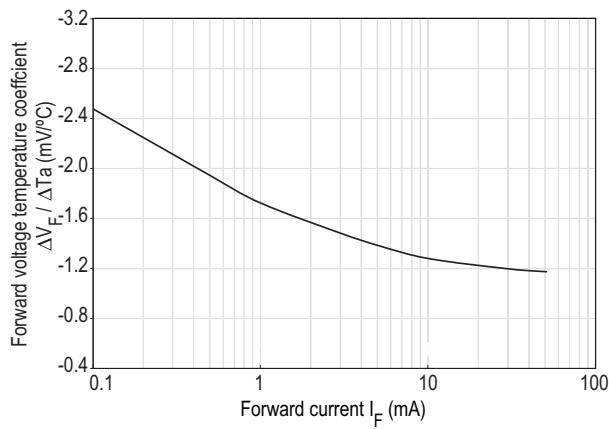


Figure 7. Forward Voltage Temperature Coefficient vs. Forward Current

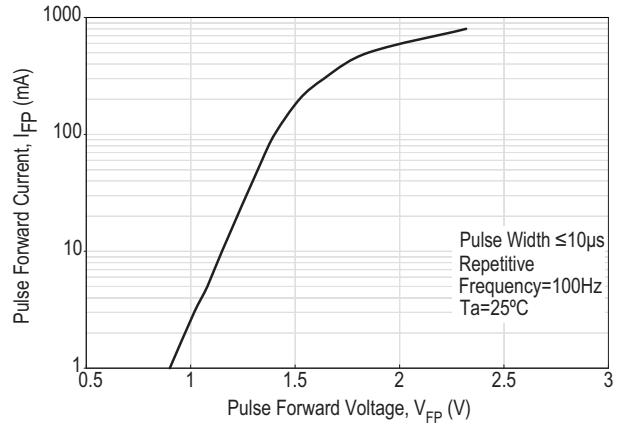


Figure 8. Pulse Forward Current vs. Pulse Forward Voltage

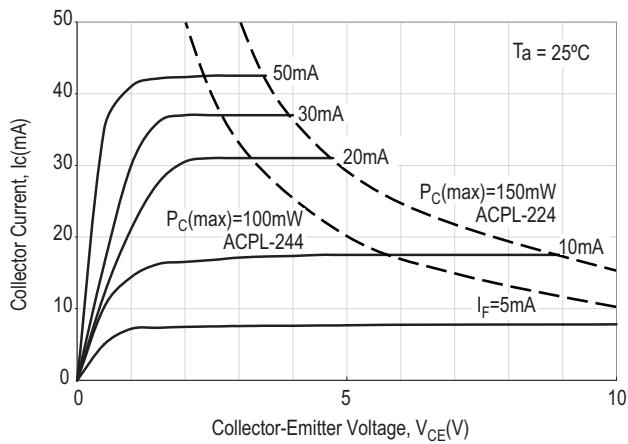


Figure 9. Collector Current vs. Collector-Emitter Voltage

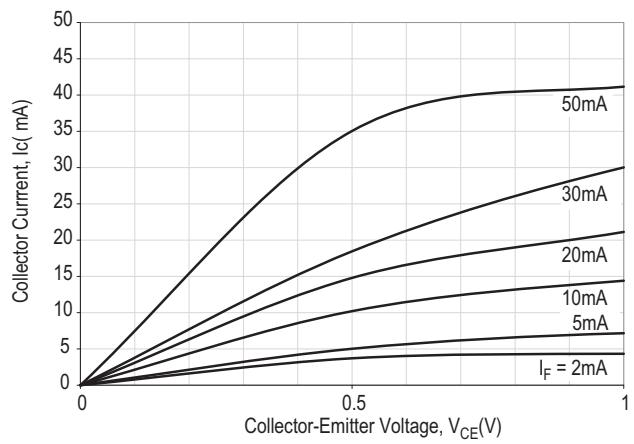


Figure 10. Collector Current vs. Small Collector-Emitter Voltage

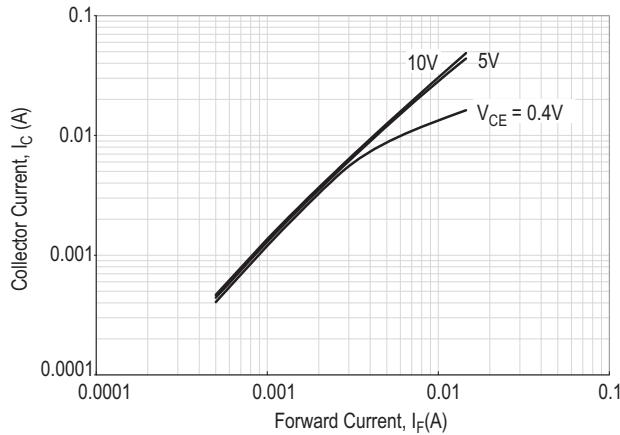


Figure 11. Collector Current vs. Forward Current

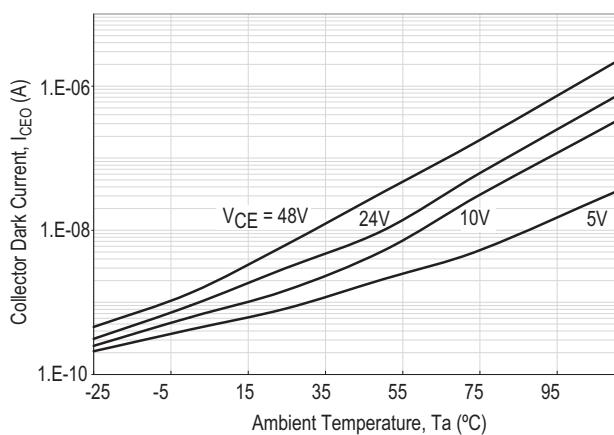


Figure 12. Collector Dark Current vs. Ambient Temperature

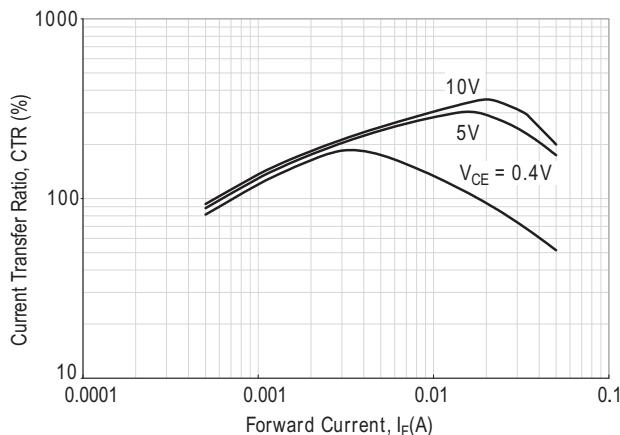


Figure 13. Current Transfer Ratio vs. Forward Current

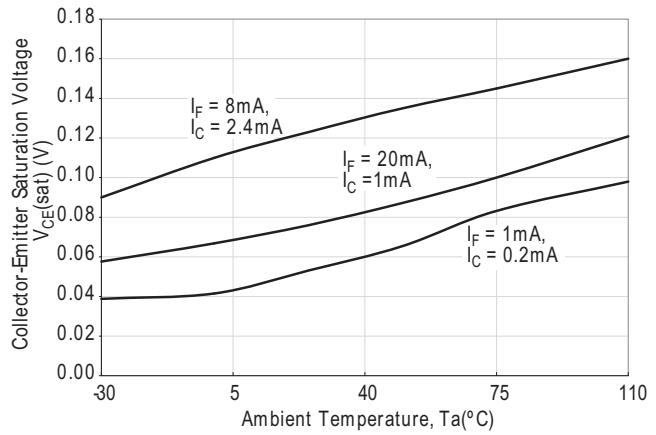


Figure 14. Collector-Emitter Saturation Voltage vs. Ambient Temperature

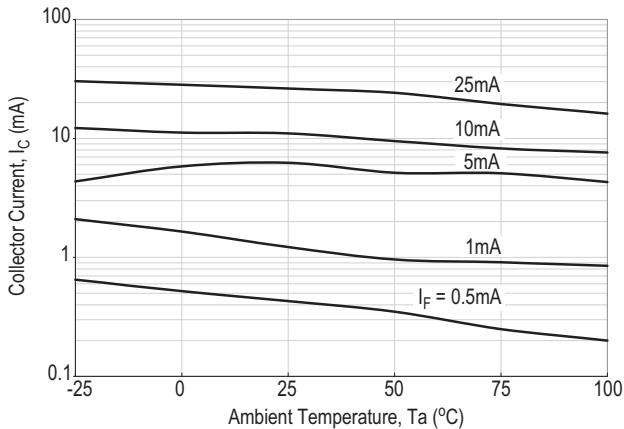


Figure 15. Collector Current vs. Ambient Temperature

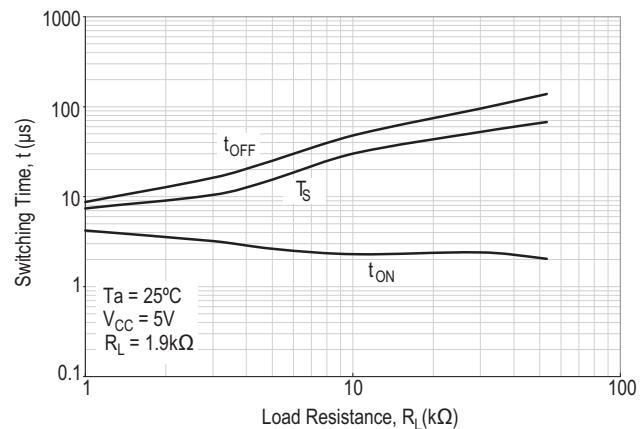


Figure 16. Switching Time vs. Load Resistance

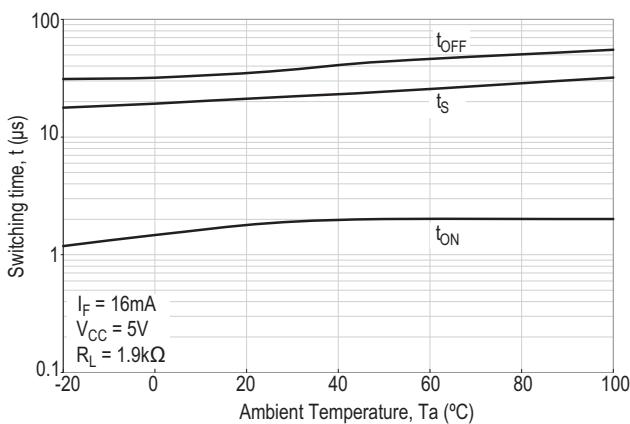


Figure 17. Switching Time vs. Ambient Temperature

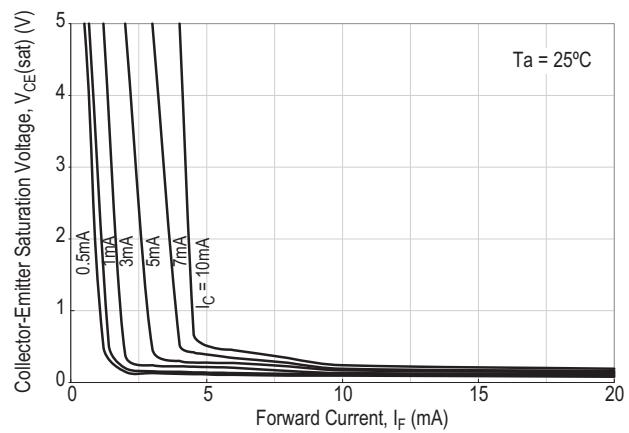


Figure 18. Collector-Emitter Saturation Voltage vs. Forward Current

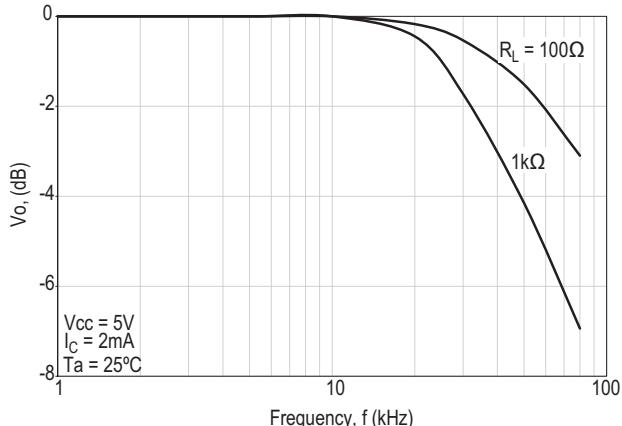
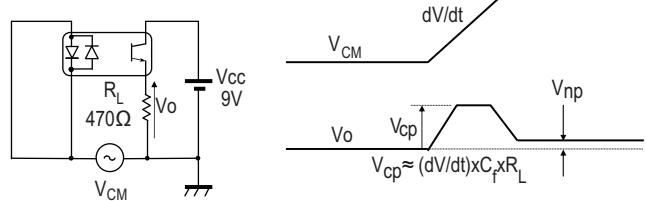


Figure 19. Frequency Response



(High Voltage Pulse)

V_{cp} : Voltage that is generated by the displacement current in floating capacitance between primary and secondary sides.

Figure 20. CMR Test Circuit

For product information and a complete list of distributors, please go to our web site: www.avagotech.com

Avago, Avago Technologies, and the A logo are trademarks of Avago Technologies in the United States and other countries.
Data subject to change. Copyright © 2005-2010 Avago Technologies. All rights reserved.
AV02-0753EN - July 20, 2010

AVAGO
TECHNOLOGIES